



Product Summary

| V _{(BR)DSS} | Rds(on) max | Ι _{D MAX} Τ _A = +25°C |
|----------------------|------------------------------|--|
| 30V | 35mΩ @ V _{GS} = 10V | 5.5A |
| 30 V | $45m\Omega @ V_{GS} = 4.5V$ | 4.9A |

Description

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- DC Motor Control
- DC-AC Inverters

Features

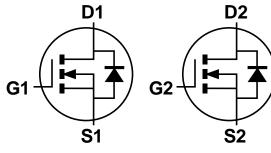
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

30V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

• Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: V-DFN3020-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @
- Weight: 0.011 grams (Approximate)



Q1 N-Channel MOSFET

Q2 N-Channel MOSFET

Equivalent Circuit

Ordering Information (Note 4)

| Part Number | Case | Packaging |
|---------------|-------------|--------------------|
| DMN3035LWN-7 | V-DFN3020-8 | 3,000/Tape & Reel |
| DMN3035LWN-13 | V-DFN3020-8 | 10,000/Tape & Reel |

S

D1

D2

Bottom View

Pin Configuration

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

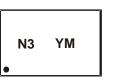
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/quality/lead_free.html.

Marking Information

V-DFN3020-8

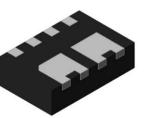


 $\begin{array}{l} N3 = \mbox{Product Type Marking Code} \\ YM = \mbox{Date Code Marking} \\ Y = \mbox{Year (ex: B = 2014)} \\ M = \mbox{Month (ex: 9 = September)} \end{array}$

| Date Code Key | | | | | | | | | | | | |
|---------------|-----|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Year | 201 | 1 | 2012 | | 2013 | 20 |)14 | 2015 | | 2016 | 2 | 2017 |
| Code | Y | | Z | | А | | В | С | | D | | E |
| | | | | | | | | | | | | |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 1 | 5 | 6 | 7 | 8 | ٩ | 0 | N | П |

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V-DFN3020-8



Bottom View



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit | |
|--|----------------|------------------|-----------------|------|---|
| Drain-Source Voltage | | V _{DSS} | 30 | V | |
| Gate-Source Voltage | | V _{GSS} | ±20 | V | |
| Continuous Drain Current (Note 6) V_{GS} = 10V | Ι _D | 5.5 4.4 | А | | |
| Maximum Continuous Body Diode Forward Curr |) | Is | 1 | А | |
| Pulsed Drain Current | | | I _{DM} | 30 | A |
| Avalanche Current (Note 7) L = 0.1mH | | I _{AS} | 13 | A | |
| Avalanche Energy (Note 7) L = 0.1mH | | E _{AS} | 9.0 | mJ | |

Thermal Characteristics

| Characteristic | Symbol | Value | Units | | |
|--|-----------------------|----------------------------------|------------|------|--|
| Total Davies Disaination (Nata 5) | T _A = 25°C | | 0.77 | 10/ | |
| Total Power Dissipation (Note 5) | T _A = 70°C | PD | 0.49 | W | |
| Thermal Desistance, lunction to Ambient (Note 5) | Steady State | | 162 | °C/W | |
| Thermal Resistance, Junction to Ambient (Note 5) | t<10s | R _θ JA | 116 | °C/w | |
| Total Dowar Discipation (Nota 6) | $T_A = 25^{\circ}C$ | P | 1.78 | W | |
| Total Power Dissipation (Note 6) | T _A = 70°C | PD | 1.10 | vv | |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | D | 71 | °C/W | |
| Thermal Resistance, Junction to Ambient (Note 6) | t<10s | $R_{	extsf{	heta}JA}$ | 50 | C/W | |
| Thermal Resistance, Junction to Case (Note 6) | | $R_{\theta JC}$ | 10.7 | °C/W | |
| Operating and Storage Temperature Range | | T _{J.} T _{STG} | -55 to 150 | °C | |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|--|---------------------|-----|----------|----------|------|--|
| OFF CHARACTERISTICS (Note 8) | Symbol | | Тур | INIAX | onit | Test condition |
| Drain-Source Breakdown Voltage | BV _{DSS} | 30 | | _ | V | $V_{GS} = 0V, I_D = 250\mu A$ |
| Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$ | I _{DSS} | _ | _ | 1.0 | μA | $V_{DS} = 30V, V_{GS} = 0V$ |
| Gate-Source Leakage | I _{GSS} | | | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ |
| ON CHARACTERISTICS (Note 8) | | | | | | ÷ |
| Gate Threshold Voltage | V _{GS(TH)} | 1.0 | — | 2.0 | V | $V_{DS} = V_{GS}, I_D = 250 \mu A$ |
| Static Drain-Source On-Resistance | R _{DS(ON)} | | 26 34 | 35 45 | mΩ | $V_{GS} = 10V, I_D = 4.8A$ $V_{GS} = 4.5V, I_D = 4.3A$ |
| Diode Forward Voltage | V _{SD} | _ | 0.75 | 1.1 | V | $V_{GS} = 0V, I_S = 1A$ |
| DYNAMIC CHARACTERISTICS (Note 9) | | | • | | | |
| Input Capacitance | Ciss | _ | 399 | — | pF | |
| Output Capacitance | Coss | — | 57 | — | pF | − V _{DS} = 15V, V _{GS} = 0V, − f = 1.0MHz |
| Reverse Transfer Capacitance | C _{rss} | — | 50 | _ | pF | 1 = 1:000112 |
| Gate Resistance | Rg | — | 1.36 | _ | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$ |
| Total Gate Charge (V _{GS} = 4.5V) | Qg | _ | 4.5 | _ | nC | |
| Total Gate Charge (V _{GS} = 10V) | Qg | — | 9.9 | _ | nC | Vps = 15V. lp = 5.8A |
| Gate-Source Charge | Q _{gs} | _ | 1.2 | — | nC | $v_{DS} = 15v, I_D = 5.6A$ |
| Gate-Drain Charge | Q _{gd} | — | 1.8 | _ | nC | |
| Turn-On Delay Time | t _{D(ON)} | _ | 3.0 | _ | ns | |
| Turn-On Rise Time | t _R | _ | 3.3 | _ | ns | V _{DD} = 15V, V _{GS} = 10V, |
| Turn-Off Delay Time | t _{D(OFF)} | _ | 10.6 | _ | ns | $R_L = 2.6\Omega, R_G = 3\Omega$ |
| Turn-Off Fall Time | t _F | _ | 2.0 | | ns | |
| Reverse Recovery Time | t _{RR} | _ | 7.9 | | ns | I _F = 4.8A, di/dt = 100A/µs |
| Reverse Recovery Charge | Q _{RR} | _ | 2.4 | _ | nC | I _F = 4.8A, di/dt = 100A/µs |

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

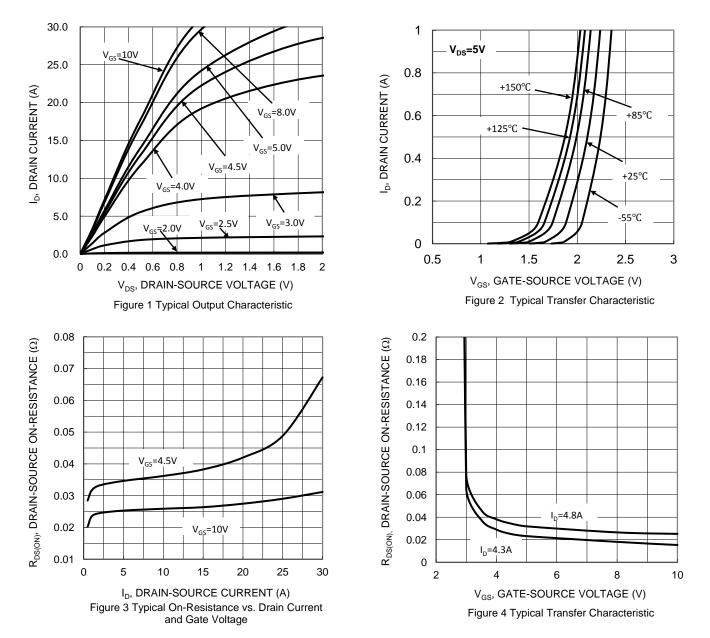
7. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep T_J = +25°C.

8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.

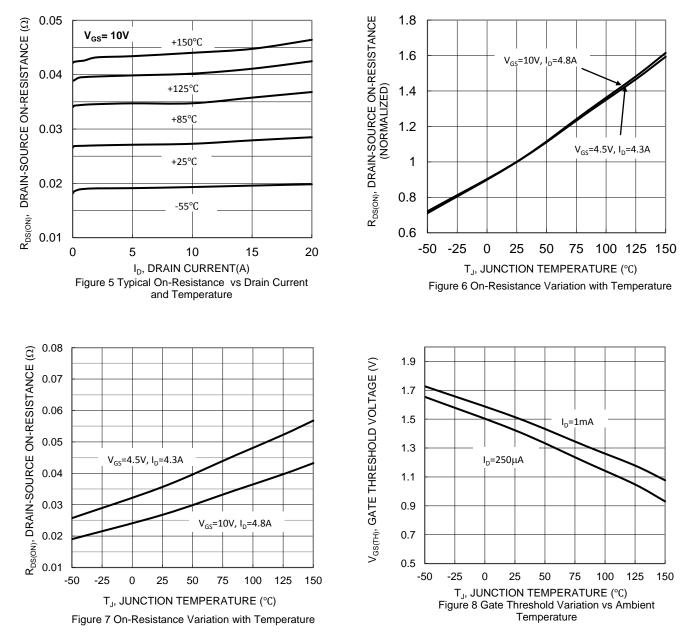


DMN3035LWN



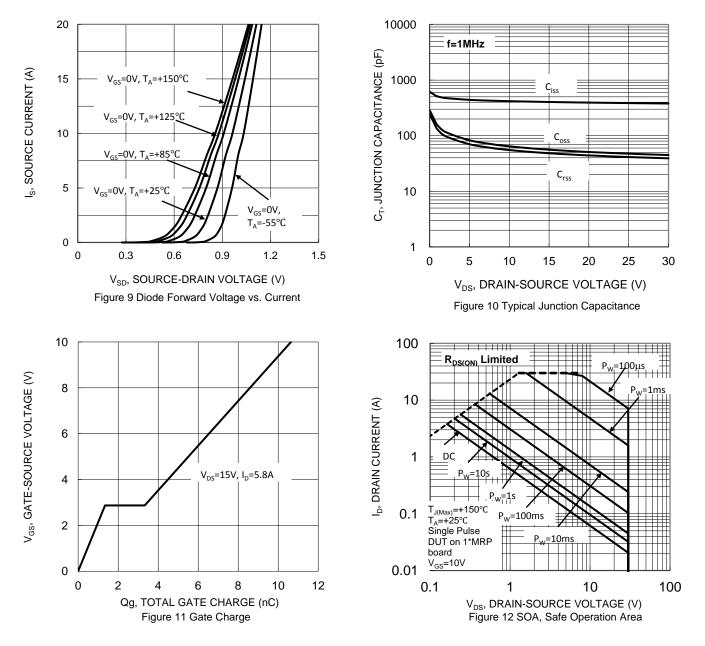


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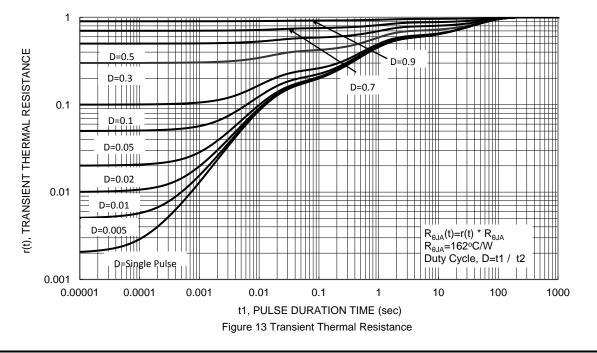




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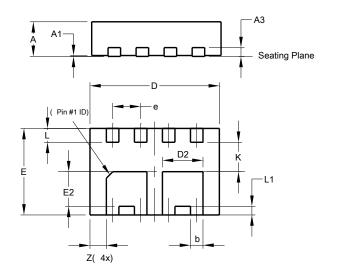






Package Outline Dimensions

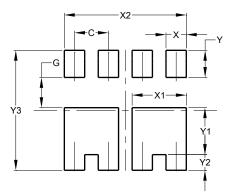
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



| V-DFN3020-8 (Type N) | | | | | | | | | |
|-------------------------|----------------------|---|-------|--|--|--|--|--|--|
| Dim | Min | <u>, , , , , , , , , , , , , , , , , , , </u> | | | | | | | |
| Α | 0.77 | 0.83 | 0.80 | | | | | | |
| A1 | 0 | 0.05 | 0.02 | | | | | | |
| A3 | - | - | 0.203 | | | | | | |
| b | 0.24 | 0.34 | 0.29 | | | | | | |
| D | 2.95 | 3.05 | 3.00 | | | | | | |
| D2 | 0.84 | 1.04 | 0.94 | | | | | | |
| e | - | - | 0.65 | | | | | | |
| Е | 1.95 | 2.05 | 2.00 | | | | | | |
| E2 | 0.70 | 0.90 | 0.80 | | | | | | |
| 1 | 0.27 | 0.37 | 0.32 | | | | | | |
| L1 | 0.15 | 0.25 | 0.20 | | | | | | |
| к | - | - | 0.68 | | | | | | |
| Z | - | - | 0.38 | | | | | | |
| All | All Dimensions in mm | | | | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version



| Dimensions | Value |
|------------|---------|
| Dimensions | (in mm) |
| С | 0.650 |
| G | 0.580 |
| Х | 0.390 |
| X1 | 1.040 |
| X2 | 2.340 |
| Y | 0.520 |
| Y1 | 0.900 |
| Y2 | 0.300 |
| Y3 | 2.300 |

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